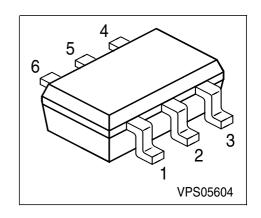
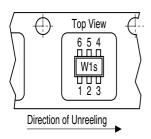


## **NPN/PNP Silicon Digital Transistor Array**

- Switching circuit, inverter, interface circuit, driver circuit
- Two (galvanic) internal isolated NPN/PNP Transistors in one package
- Built in bias resistor ( $R_1$ =4.7k $\Omega$ ,  $R_2$ =4.7k $\Omega$ )



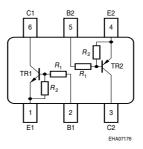
### Tape loading orientation



Marking on SOT-363 package (for example W1s) corresponds to pin 1 of device

Position in tape: pin 1 opposite of feed hole side

EHA07193



Туре	Marking		Pin Configuration Package					
BCR15PN	WAs	1=E1	2=B1	3=C2	4=E2	5=B2	6=C1	SOT363

### **Maximum Ratings**

Parameter	Symbol	Value	Unit
Collector-emitter voltage	V <sub>CEO</sub>	50	V
Collector-base voltage	V <sub>CBO</sub>	50	
Emitter-base voltage	$V_{EBO}$	10	
Input on Voltage	V <sub>i(on)</sub>	15	
DC collector current	I <sub>C</sub>	100	mA
Total power dissipation, $T_S$ = 115 °C	P <sub>tot</sub>	250	mW
Junction temperature	T <sub>j</sub>	150	°C
Storage temperature	T <sub>stg</sub>	-65 150	

### **Thermal Resistance**

Junction - soldering point <sup>1)</sup>	R <sub>thJS</sub>	≤ 140	K/W

 $<sup>^{1}\</sup>mathrm{For}$  calculation of  $R_{\mathrm{thJA}}$  please refer to Application Note Thermal Resistance



**Electrical Characteristics** at  $T_A$ =25°C, unless otherwise specified

Parameter	Symbol	Values			Unit
		min.	typ.	max.	1
DC Characteristics				•	•
Collector-emitter breakdown voltage	V <sub>(BR)CEO</sub>	50	-	-	V
$I_{\rm C} = 100 \ \mu \text{A}, \ I_{\rm B} = 0$					
Collector-base breakdown voltage	V <sub>(BR)CBO</sub>	50	-	-	
$I_{\rm C} = 10 \ \mu {\rm A}, \ I_{\rm E} = 0$					
Collector cutoff current	I <sub>CBO</sub>	-	-	100	nA
$V_{\rm CB} = 40 \text{ V}, I_{\rm E} = 0$					
Emitter cutoff current	I <sub>EBO</sub>	-	-	1.61	mA
$V_{\rm EB}$ = 10 V, $I_{\rm C}$ = 0					
DC current gain 1)	h <sub>FE</sub>	20	-	-	-
$I_{\rm C}$ = 5 mA, $V_{\rm CE}$ = 5 V					
Collector-emitter saturation voltage1)	V <sub>CEsat</sub>	-	-	0.3	V
$I_{\rm C}$ = 10 mA, $I_{\rm B}$ = 0.5 mA					
Input off voltage	$V_{i(off)}$	8.0	-	1.5	
$I_{\rm C}$ = 100 $\mu$ A, $V_{\rm CE}$ = 5 V					
Input on Voltage	V <sub>i(on)</sub>	1	-	2.5	
$I_{\rm C}$ = 2 mA, $V_{\rm CE}$ = 0.3 V					
Input resistor	R <sub>1</sub>	3.2	4.7	6.2	kΩ
Resistor ratio	$R_1/R_2$	0.9	1	1.1	-
AC Characteristics					
Transition frequency	f <sub>T</sub>	-	140	-	MHz
$I_{\rm C}$ = 10 mA, $V_{\rm CE}$ = 5 V, $f$ = 100 MHz					
Collector-base capacitance	$C_{ m cb}$	_	3	_	pF
$V_{\text{CB}} = 10 \text{ V}, f = 1 \text{ MHz}$					

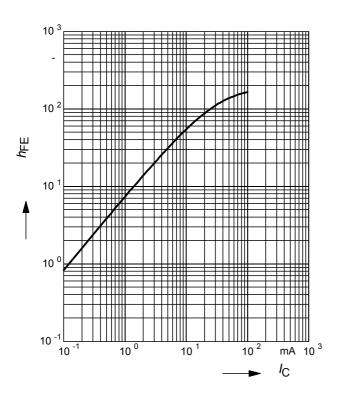
<sup>1)</sup> Pulse test: t < 300μs; D < 2%



# **NPN Type**

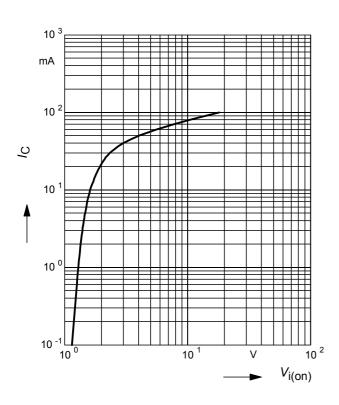
# **DC** Current Gain $h_{FE} = f(I_C)$

 $V_{CE} = 5V$  (common emitter configuration)



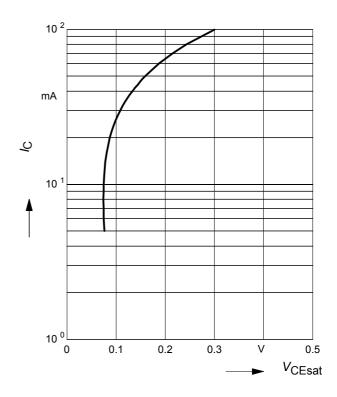
# Input on Voltage $V_{i(on)} = f(I_C)$

 $V_{CE} = 0.3V$  (common emitter configuration)



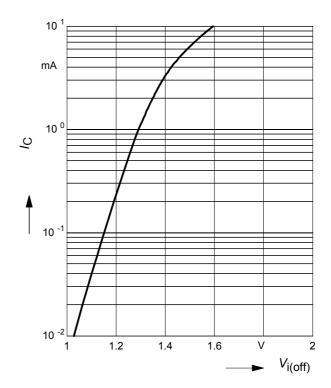
# **Collector-Emitter Saturation Voltage**

 $V_{\text{CEsat}} = f(I_{\text{C}}), h_{\text{FE}} = 20$ 



# Input off voltage $V_{i(off)} = f(I_C)$

 $V_{CE} = 5V$  (common emitter configuration)

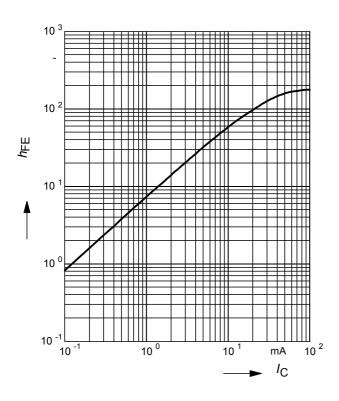




# **PNP Type**

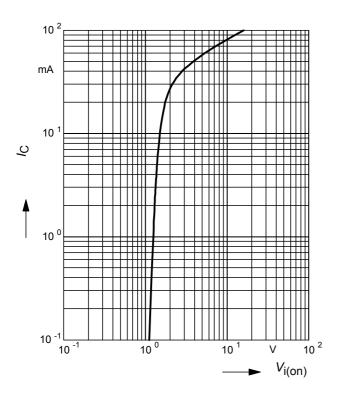
# **DC** Current Gain $h_{FE} = f(I_C)$

 $V_{CE} = 5V$  (common emitter configuration)



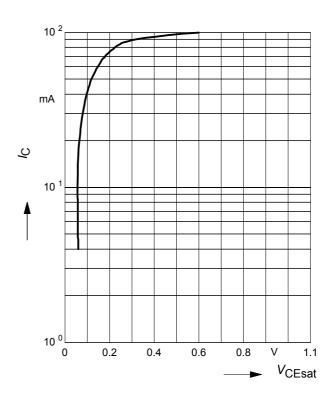
# Input on Voltage $V_{i(ON)} = f(I_C)$

 $V_{CE} = 0.3V$  (common emitter configuration)



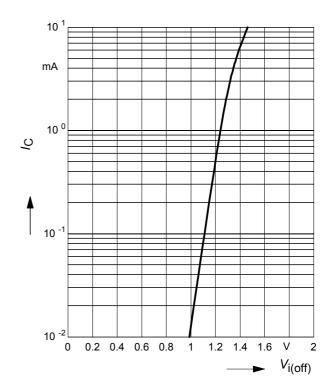
# **Collector-Emitter Saturation Voltage**

 $V_{\text{CEsat}} = f(I_{\text{C}}), h_{\text{FE}} = 20$ 



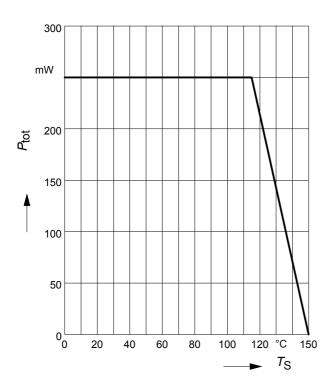
# Input off voltage $V_{i(Off)} = f(I_C)$

 $V_{CE}$  = 5V (common emitter configuration)





# Total power dissipation $P_{\text{tot}} = f(T_{\text{S}})$



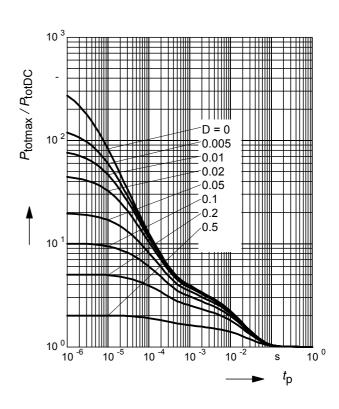
# Permissible Pulse Load $R_{thJS} = f(t_p)$

10 <sup>3</sup>

# NOTE TO THE TOTAL T

# **Permissible Pulse Load**

$$P_{\text{totmax}} / P_{\text{totDC}} = f(t_{p})$$



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